# 506630167 04/26/2021

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6676976

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
CARL HARDIN	04/08/2021
BRIAN CLARKE BANISTER	02/22/2021
SHRENIK PATEL	03/16/2021
MICHAEL KOHLMANN	03/05/2021
LIANG ZHAO	03/16/2021
LE NGUYEN LUONG	02/10/2021
TEVFIK YUCEK	02/12/2021
ROLAND RICK	03/09/2021
SHRIRAM GURUMOORTHY	03/19/2021
FRANCIS NGAI	04/02/2021

#### **RECEIVING PARTY DATA**

Name:	QUALCOMM INCORPORATED
Street Address: 5775 MOREHOUSE DRIVE	
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

## **PROPERTY NUMBERS Total: 2**

Property Type	Number
Application Number:	17171915
Application Number:	62972597

#### **CORRESPONDENCE DATA**

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email: qualcomm-pto@lozaip.com

Correspondent Name: LOZA & LOZA, LLP/QUALCOMM
Address Line 1: 305 NORTH SECOND AVE., # 127
Address Line 4: UPLAND, CALIFORNIA 91726

ATTORNEY DOCKET NUMBER: QCOM-4079US (202516)

PATENT REEL: 056044 FRAME: 0718

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NAME OF SUBMITTER:	JULIO LOZA		
SIGNATURE:	GNATURE: /Julio Loza/		
<b>DATE SIGNED:</b> 04/26/2021			
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## **ASSIGNMENT**

WHEREAS, WE,

- 1. Carl HARDIN, having a mailing address located at 5775 Morehouse Drive San Diego, CA 92121-1714.
- 2. Brian Clarke BANISTER, having a mailing address located at 5775 Morehouse Drive San Diego, CA 92121-1714,
- 3. Shrenik PATEL, having a mailing address located at 5775 Morehouse Drive San Diego, CA 92121-1714.
- 4. **Michael KOHLMANN,** having a mailing address located at **5775 Morehouse Drive San Diego, CA 92121-1714**,
- 5. Liang ZHAO, having a mailing address located at 5775 Morehouse Drive San Diego, CA 92121-1714.
- 6. Le Nguyen LUONG, having a mailing address located at 5775 Morehouse Drive San Diego, CA 92121-1714,
- 7. Tevfik YUCEK, having a mailing address located at 5775 Morehouse Drive San Diego, CA 92121-1714.
- 8. Roland RICK, having a mailing address located at 5775 Morehouse Drive San Diego, CA 92121-1714.
- 9. Shriram GURUMOORTHY, having a mailing address located at 5775 Morehouse Drive San Diego, CA 92121-1714,
- 10. Francis NGAI, having a mailing address located at 5775 Morehouse Drive San Diego, CA 92121-1714.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to RADIO FREQUENCY COEXISTENCE MITIGATIONS WITHIN WIRELESS USER EQUIPMENT HANDSETS (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications

therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 17/171,915 filed February 9, 2021, Qualcomm Reference Number 202516, and all provisional applications relating thereto, together with U.S Provisional Application No(s). 62/972,597, filed February 10, 2020, Qualcomm Reference Number 202516P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any

ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at		, on	
	City, State, Country		Carl HARDIN
Done at	City, State, Country		Brian Clarke BANISTER
Done at	City, State, Country		Shrenik PATEL
Done at	City, State, Country		Michael KOHLMANN

Done at		, on		
	City, State, Country		Date	Liang ZHAO
Done at	City, State, Country	, on	Date	Le Nguyen LUONG
Done at	City, State, Country	, on	Date	Tevfik YUCEK
Done at	City, State, Country	, on	Date	Roland RICK
Done at	City, State, Country		Date	Shriram GURUMOORTHY
Done at	City, State, Country		 Date	Francis NGAI

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Done at	City State Country	on <u>App</u>	2-021	Carl HARDIN
Pone at	City, State: Country	, on	Date	Brian Clarke BANISTER
Done at	City State, Country	, оп	Date	Shrenik PATEI.
Done at	See Courts	, on	Date	Michael KOHLMANN

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Done at		, on	
	City, State, Country	Date	Carl HARDIN
Done at	San Dieso CA USA City, State, Country	on <u>22 FeA 2-02</u> 1 Date	Brian Clarke BANISTER
Done at	City, State, Country	, on Date	Shrenik PATEL
Done at	City, State, Country	, on Date	Michael KOHLMANN

Qualcomm Reference Number: 202516

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ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance:

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	on ,		
	City, State, Country	Date	Carl HARDIN
Done at	, on _	Date	Brian Clarke BANISTER
Done at	San Diego, CA, USA on City, State, Country	3/16/2021 Date	Shrenik PATEL
Done at		Date	Michael KOHLMANN

ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries:

	City, State, Country	on Date	Carl HARDIN
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	City, State, Country	Date	Brian Clarke BANISTER
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	City, State, Country	Date	Shrenik PATEL
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Done at	Saratoga, CA, US	A, on03/1	6/2021	_/Liang Zhao/
	City, State, Country		Date	Liang ZHAO
Done at	City, State, Country		Date	Le Nguyen LUONG
Done at	City, State, Country		Date	Tevfik YUCEK
Done at	City, State, Country	, on	Date	Roland RICK
Done at	City, State, Country	, on	Date	Shriram GURUMOORTHY
	City, State, Country			Francis NGAI

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Qualcomm Reference Number: 202516

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at		on		
	City, State, Country			Liang ZHAO
Done at	Sain Diego, (A. City, State, Country	, on <u>02/10/</u>	2021 Date	Le Nguyen LCONG
Done at	City, State, Country	, on	Date	Tevfik YUCEK
Done at	City, State, Country	, on	Date	Roland RICK
Done at	City, State, Country		Date	Shriram GURUMOORTHY
Done at	City, State, Country	, on	Date	Francis NGAI
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City, State, Country	Date	Liang ZHAO
City State Country	Date	Le Nguyen LUONG
Jose, CA, USA	2011-02-12	THAS )
City State Country	Date	Tevfik YUCEK
Cay, Sizie, Country	Date	Roland RICK
City State, Country	Date	Shriram GURUMOORTHY
Cry State County		Roland RICK

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Qualcomm Reference Number: 202516

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Done at		on	
	City, State, Country	Date	Liang ZHAO
Done at	City, State, Country	onDate	Le Nguyen LUONG
Done at	City, State, Country	onDate	Tevfik YUCEK
Done at	Arvada, Co, U.; City, State, Country	on 3/9/24 Date	Roland RICK
Done at	City, State, Country	onDate	Shriram GURUMOORTHY
Done at	City, State, Country	onDate	Francis NGAI

Done at, on City, State, Country		
, , , , , , , , , , , , , , , , , , , ,	Date	Liang ZHAO
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	Ø3C	Shriram GURUMOORTHY
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e at, on City, State, Country		

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	City, State, Country		Date	Liang ZHAO
Done at	City, State, Country	, on		Le Nguyen LUONG
Done at	City, State, Country	, on	Date	Tevfik YUCEK
Done at	City, State, Country	, on	Date	Roland RICK
Done at	City, State, Country	, on	Date	Shriram GURUMOORTHY
	USA City, State, Country		<u>2,2</u> 02红 Date	Francis NGAI

PATENT REEL: 056044 FRAME: 0733

**RECORDED: 04/26/2021**